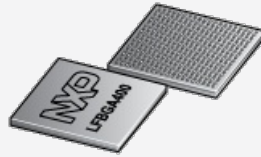


MCIMX250CJM4A (Active)

i.MX25 32-bit MPU, ARM926EJ-S core, 400MHz, MAPBGA 400



Package: [LFBGA400](#)

LFBGA400; plastic, low profile fine-pitch ball grid array; 400 bumps; 0.8 mm pitch; 17 mm x 17 mm x 1.44 mm body

[Buy Options](#) | [Environmental Information](#) | [Quality Information](#) | [Shipping Information](#)

Buy Options

MCIMX250CJM4A Active TRAY-Tray, Bakeable, Multiple in Drypack Distributor
 935324402557 Min. Package Quantity: 90
 Lead Time: 15 weeks

Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
MCIMX250CJM4A (935324402557)	Yes	Yes Certificate Of Analysis (CoA)	Yes	D	e1	REACH SVHC	838.7

Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Tin
		Lead Free Soldering	Lead Free Soldering	Le
MCIMX250CJM4A (935324402557)	No	3	260	

Shipping Information

Part Number	Harmonized Tariff (US) Disclaimer	Export Control Classification Number (US)
MCIMX250CJM4A (935324402557)	854231	5A992

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